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August 2016

FAN7842

High- and Low-Side Gate Driver

Features

- Floating Channels Designed for Bootstrap Operation to +200 V
- Typically 350 mA/650 mA Sourcing/Sinking Current Driving Capability for Both Channels
- Common-Mode dv/dt Noise Canceling Circuit
- Extended Allowable Negative V_S Swing to -9.8 V for Signal Propagation at V_{CC}=V_{BS}=15 V
- V_{CC} & V_{BS} Supply Range from 10 V to 20 V
- UVLO Functions for Both Channels
- TTL Compatible Input Logic Threshold Levels
- Matched Propagation Delay Below 50 nsec
- Output In-phase with Input Signal

Applications

- Battery based motor applications (E-bike, Power Tool)
- Telecom DC-DC converter

Related Resources

- AN-6076 Design and Application Guide of Bootstrap Circuit for High-Voltage Gate-Drive IC
- AN-9052 Design Guide for Selection of Bootstrap Components
- <u>AN-8102 Recommendations to Avoid Short Pulse</u> Width Issues in HVIC Gate Driver Applications

Description

The FAN7842, a monolithic high and low side gate drive IC, which can drive MOSFETs and IGBTs that operate up to +200 V.

Fairchild's high-voltage process and common-mode noise canceling technique provide stable operation of the high-side driver under high-dv/dt noise circumstances. An advanced level-shift circuit allows high-side gate driver operation up to Vs=-9.8V (typical) for VBs=15V. The input logic level is compatible with standard TTL-series logic gates.

The UVLO circuits for both channels prevent malfunction when Vcc and Vbs are lower than the specified threshold voltage. Output driver current (source/sink) is typically 350mA/650mA, respectively.

8-SOP



Ordering Information

Part Number	Package	Operating Temperature Range	Packing Method
FAN7842MX ⁽¹⁾	8-SOP	-40°C ~ 125°C	Tape & Reel

Note:

1. These devices passed wave soldering test by JESD22A-111.

Typical Application Circuit

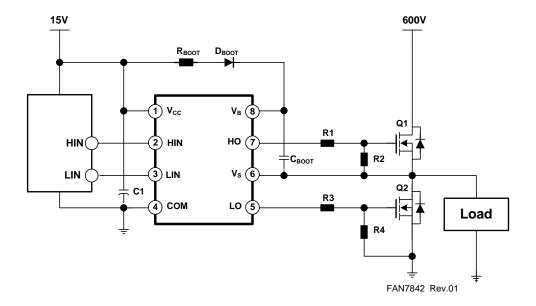


Figure 1. Application Circuit for Half-Bridge

Internal Block Diagram

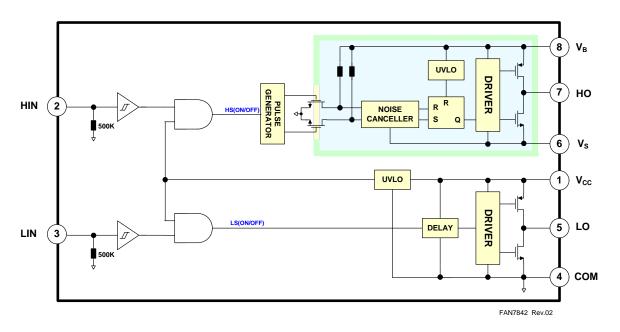


Figure 2. Functional Block Diagram

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Pin Assignments

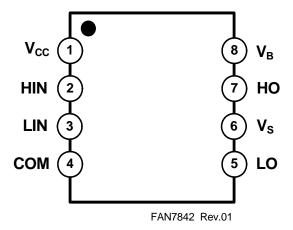


Figure 3. Pin Configuration (Top View)

Pin Definitions

Name	Description		
V _{CC}	Low-Side Supply Voltage		
HIN	Logic Input for High-Side Gate Driver Output		
LIN	Logic Input for Low-Side Gate Driver Output		
COM	Logic Ground and Low-Side Driver Return		
LO	Low-Side Driver Output		
V _S	High-Voltage Floating Supply Return		
НО	High-Side Driver Output		
V _B	High-Side Floating Supply		

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Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Characteristics	Min.	Max.	Unit
V _S	High-side offset voltage	V _B -25	V _B +0.3	
V _B	High-side floating supply voltage	-0.3	225	
V _{HO}	High-side floating output voltage HO	V _S -0.3	V _B +0.3	
V _{CC}	Low-side and logic fixed supply voltage	-0.3	25	V
V _{LO}	Low-side output voltage LO	-0.3	V _{CC} +0.3	
V _{IN}	Logic input voltage (HIN, LIN)	-0.3	V _{CC} +0.3	
COM	Logic ground	V _{CC} -25	V _{CC} +0.3	
dV _S /dt	Allowable offset voltage slew rate		50	V/ns
P _D ⁽²⁾⁽³⁾⁽⁴⁾	Power dissipation		0.625	W
θ_{JA}	Thermal resistance, junction-to-ambient		200	°C/W
T _J	Junction temperature		150	°C
T _{STG}	Storage temperature		150	°C

Notes:

- 2. Mounted on 76.2 x 114.3 x 1.6 mm PCB (FR-4 glass epoxy material).
- 3. Refer to the following standards:
 - JESD51-2: Integral circuits thermal test method environmental conditions natural convection JESD51-3: Low effective thermal conductivity test board for leaded surface mount packages
- 4. Do not exceed P_D under any circumstances.

Recommended Operating Ratings

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Max.	Unit
V _B	High-side floating supply voltage	V _S +10	V _S +20	
V _S	High-side floating supply offset voltage	6-V _{CC}	200	
V _{HO}	High-side (HO) output voltage	V _S	V _B	V
V_{LO}	Low-side (LO) output voltage	COM	V _{CC}	ľ
V _{IN}	Logic input voltage (HIN, LIN)	COM	V _{CC}	
V _{CC}	Low-side supply voltage	10	20	
T _A	Ambient temperature	-40	125	°C

Electrical Characteristics

 V_{BIAS} (V_{CC} , V_{BS})=15.0 V, T_A = 25°C, unless otherwise specified. The V_{IN} and I_{IN} parameters are referenced to COM. The V_O and I_O parameters are referenced to V_S and COM and are applicable to the respective outputs HO and LO.

Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit
V _{CCUV+} V _{BSUV+}	V _{CC} and V _{BS} supply under-voltage positive going threshold		8.2	9.2	10.0	
V _{CCUV-} V _{BSUV-}	V _{CC} and V _{BS} supply under-voltage negative going threshold		7.6	8.7	9.6	V
V _{CCUVH} V _{BSUVH}	V _{CC} supply under-voltage lockout hysteresis			0.6		
I _{LK}	Offset supply leakage current	V _B =V _S =200 V			50	
I _{QBS}	Quiescent V _{BS} supply current	V _{IN} =0V or 5 V		45	120	μΑ
I _{QCC}	Quiescent V _{CC} supply current	V _{IN} =0V or 5 V		70	180	
I _{PBS}	Operating V _{BS} supply current	f _{IN} =20 kHz, rms value			600	пΛ
I _{PCC}	Operating V _{CC} supply current	f _{IN} =20 kHz, rms value			600	μA
V _{IH}	Logic "1" input voltage		2.9			
V _{IL}	Logic "0" input voltage				0.8	V
V _{OH}	High-level output voltage, V _{BIAS} -V _O	L _30 mA			1.0]
V _{OL}	Low-level output voltage, V _O	- I _O =20 mA			0.6	
I _{IN+}	Logic "1" input bias current	V _{IN} =5 V		10	20	
I _{IN-}	Logic "0" input bias current	V _{IN} =0 V		1.0	2.0	μA
I _{O+}	Output high short-circuit pulsed current	V _O =0 V, V _{IN} =5 V with PW<10 μs	250	350		mA
I _{O-}	Output low short-circuit pulsed current	V_O =15 V, V_{IN} =0 V with PW<10 µs	500	650		IIIA
Vs	Allowable negative V _S pin voltage for HIN signal propagation to HO			-9.8	-7.0	V

Dynamic Electrical Characteristics

 V_{BIAS} (V_{CC} , V_{BS})=15.0 V, V_{S} =COM, C_{L} =1000pF and, T_{A} = 25°C, unless otherwise specified.

Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit
t _{on}	Turn-on propagation delay	V _S =0 V	100	170	300	
t _{off}	Turn-off propagation delay	V _S =0 V or 200 V ⁽⁵⁾	100	200	300	
t _r	Turn-on rise time		20	60	140	ns
t _f	Turn-off fall time			30	80	
MT	Delay matching, HS & LS turn-on/off				50	

Note:

5. This parameter guaranteed by design.

Typical Characteristics

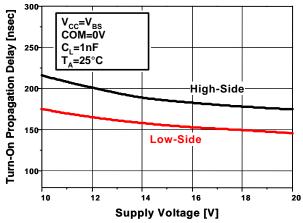


Figure 4. Turn-On Propagation Delay vs. Supply Voltage

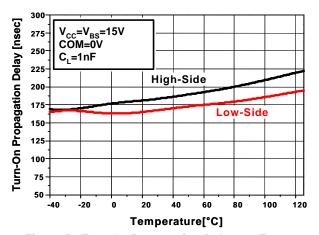


Figure 5. Turn-On Propagation Delay vs. Temp.

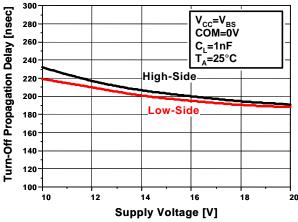


Figure 6. Turn-Off Propagation Delay vs. Supply Voltage

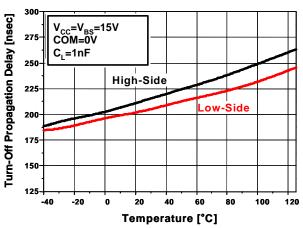


Figure 7. Turn-Off Propagation Delay vs. Temp.

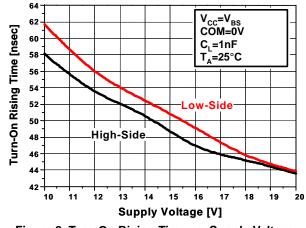


Figure 8. Turn-On Rising Time vs. Supply Voltage

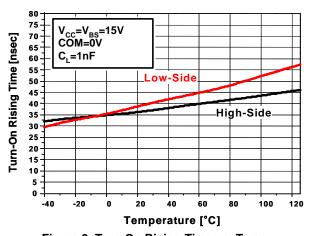


Figure 9. Turn-On Rising Time vs. Temp.

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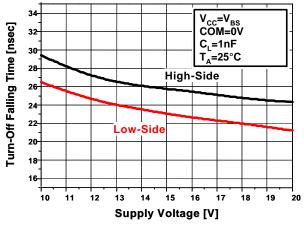


Figure 10. Turn-Off Falling Time vs. Supply Voltage

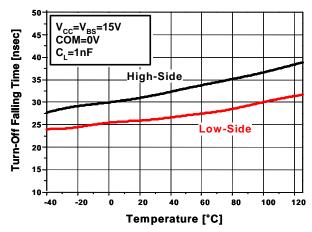


Figure 11. Turn-Off Falling Time vs. Temp.

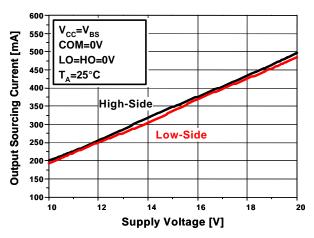


Figure 12. Output Sourcing Current vs. Supply Voltage

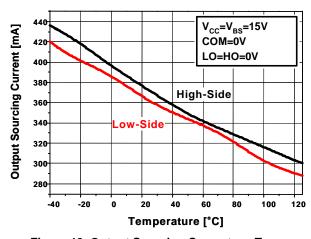


Figure 13. Output Sourcing Current vs. Temp

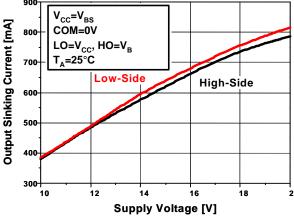


Figure 14. Output Sinking Current vs. Supply Voltage

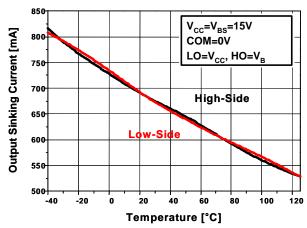


Figure 15. Output Sinking Current vs. Temp.

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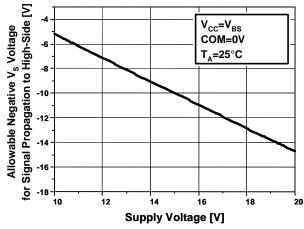


Figure 16. Allowable Negative V_S Voltage for Signal Propagation to High Side vs. Supply Voltage

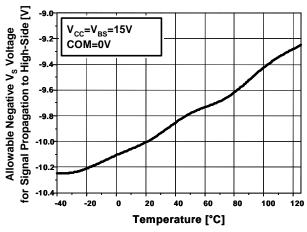


Figure 17. Allowable Negative V_S Voltage for Signal Propagation to High Side vs. Temp.

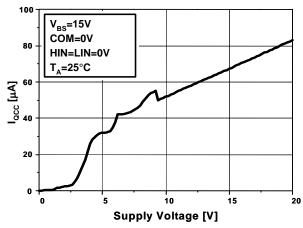


Figure 18. I_{QCC} vs. Supply Voltage

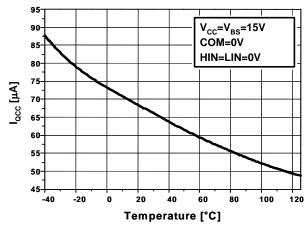


Figure 19. I_{QCC} vs. Temp.

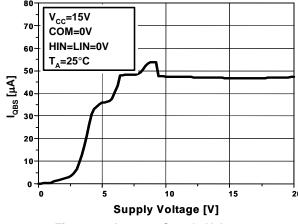


Figure 20. I_{QBS} vs. Supply Voltage

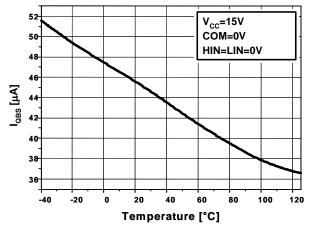


Figure 21. I_{QBS} vs. Temp.

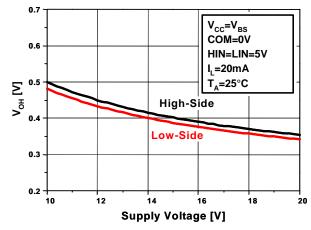


Figure 22. High-Level Output Voltage vs. **Supply Voltage**

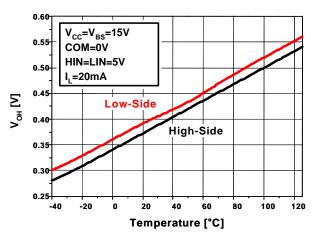


Figure 23. High-Level Output Voltage vs. Temp.

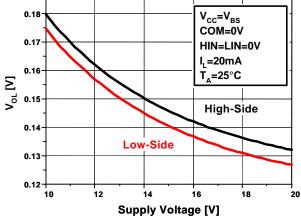


Figure 24. Low-Level Output Voltage vs. **Supply Voltage**

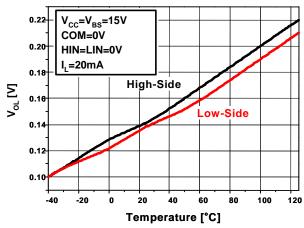
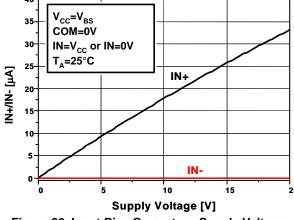
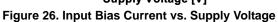


Figure 25. Low-Level Output Voltage vs. Temp.





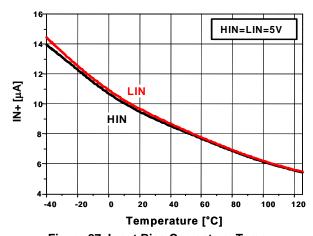


Figure 27. Input Bias Current vs. Temp.

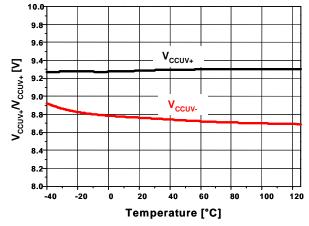


Figure 28. V_{CC} UVLO Threshold Voltage vs. Temp.

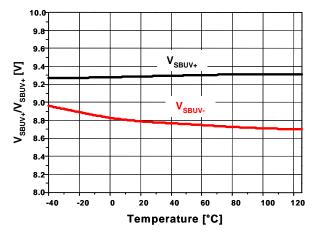


Figure 29. V_{BS} UVLO Threshold Voltage vs. Temp.

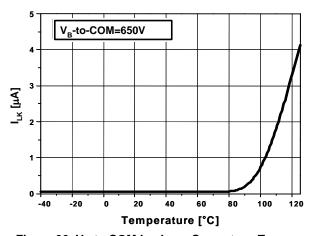


Figure 30. V_B to COM Leakage Current vs. Temp.

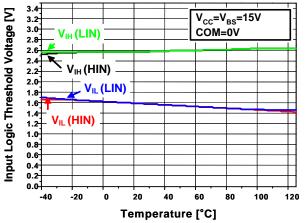


Figure 31. Input Logic Threshold Voltage vs. Temp.

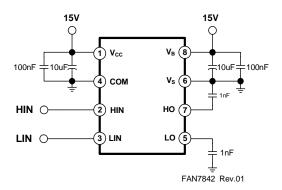


Figure 32. Switching Time Test Circuit

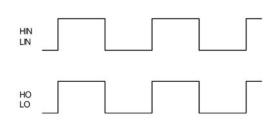


Figure 33. Input / Output Timing Diagram

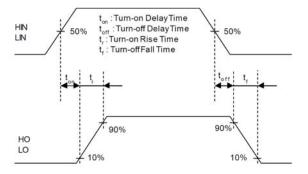


Figure 34. Switching Time Waveform Definition

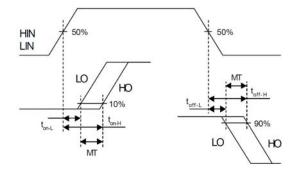
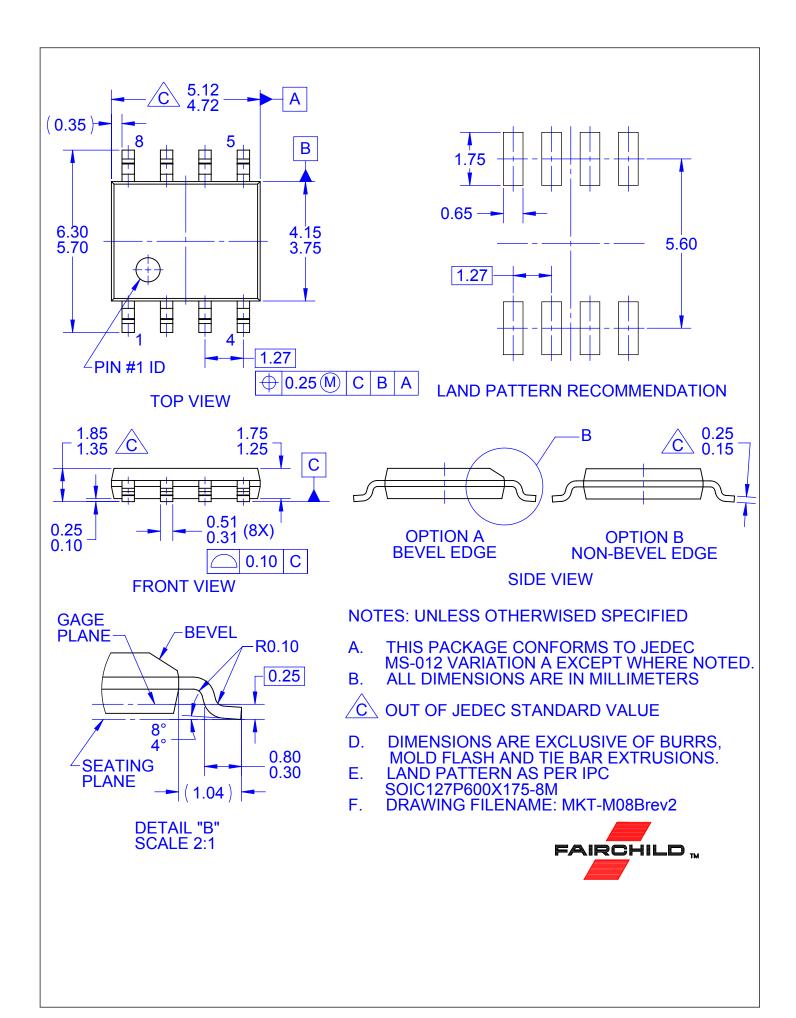


Figure 35. Delay Matching Waveform Definition



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